

PRODUCT DATASHEET Leila series

last update 23/8/2012









Ordering number CP11631_LXP3-RS

Family Leila Type Assembly XP-G LED Color White Diameter 21.6 mm Height 14.6 mm Style Round **PMMA** Optic Material PC Holder Material Fastening Glue Status Ready

FWHM 10 degrees
Efficiency 92 %
cd/lm 16.500
Gerber File Available

Suitable for Star PCB

Ordering number CP11632_LXP3-D

Family Leila Type Assembly **LED** XP-G Color White Diameter 21.6 mm Height 14.6 mm Style Round **PMMA** Optic Material PC Holder Material Fastening Glue Status Ready

FWHM 11 degrees
Efficiency 94 %
cd/lm 11.000
Gerber File Available

Suitable for Star PCB

Ordering number CP11634_LXP3-O-90

Leila Family Type Assembly **LED** XP-G Color White 21.6 mm Diameter Height 14.6 mm Round Style **PMMA** Optic Material Holder Material PC Fastening Glue Status Ready

FWHM 14+40 degrees

Efficiency 93 % cd/lm 4.800 Gerber File Available

Ordering number CP11633_LXP3-M

Family Leila Assembly Type LED XP-G Color White Diameter 21.6 mm Height 14.6 mm Style Round Optic Material **PMMA** Holder Material PC Fastening Glue

Status

FWHM 24 degrees
Efficiency 94 %
cd/lm -

Gerber File Available

Suitable for Star PCB

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Ready



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NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.



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GENERAL INFORMATION

- Product series especially designed & optimized for XP-G series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Lens material optical grade PMMA with high UV and temperature resistance (105 degrees of Celcius / 220 degrees of Fahrenheit). Allows use of high current and temperature conditions.

Please find more information about used material from below:

http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20UL94_Yellow%20Card.pdf http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20PLEXIGLAS-Datasheet.pdf

- Optic holder molded by high quality PC material (120 dergees of Celcius / 248 degrees of Fahrenheit).
- Fastening to PCB with appropriate adhesive. By clicking link below you can find Ledil recommended glue options.

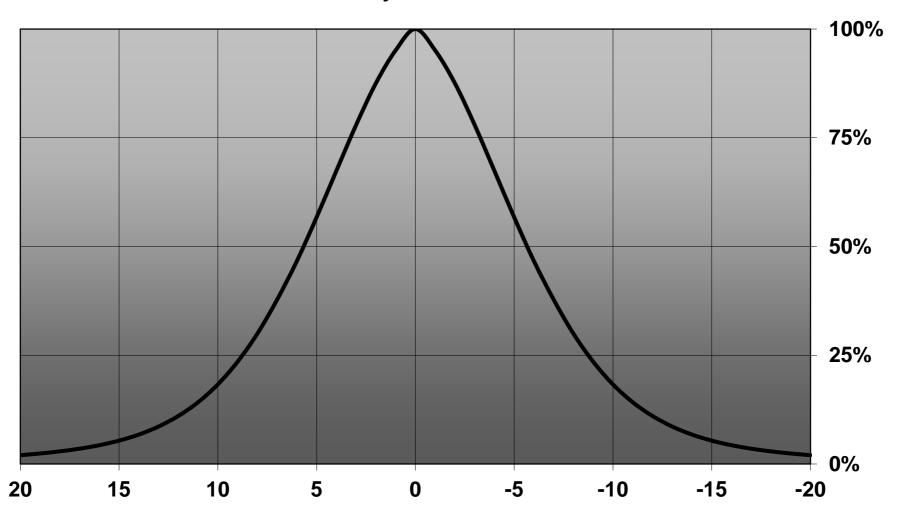
http://www.ledil.com/datasheets/DataSheet_GLUES.pdf

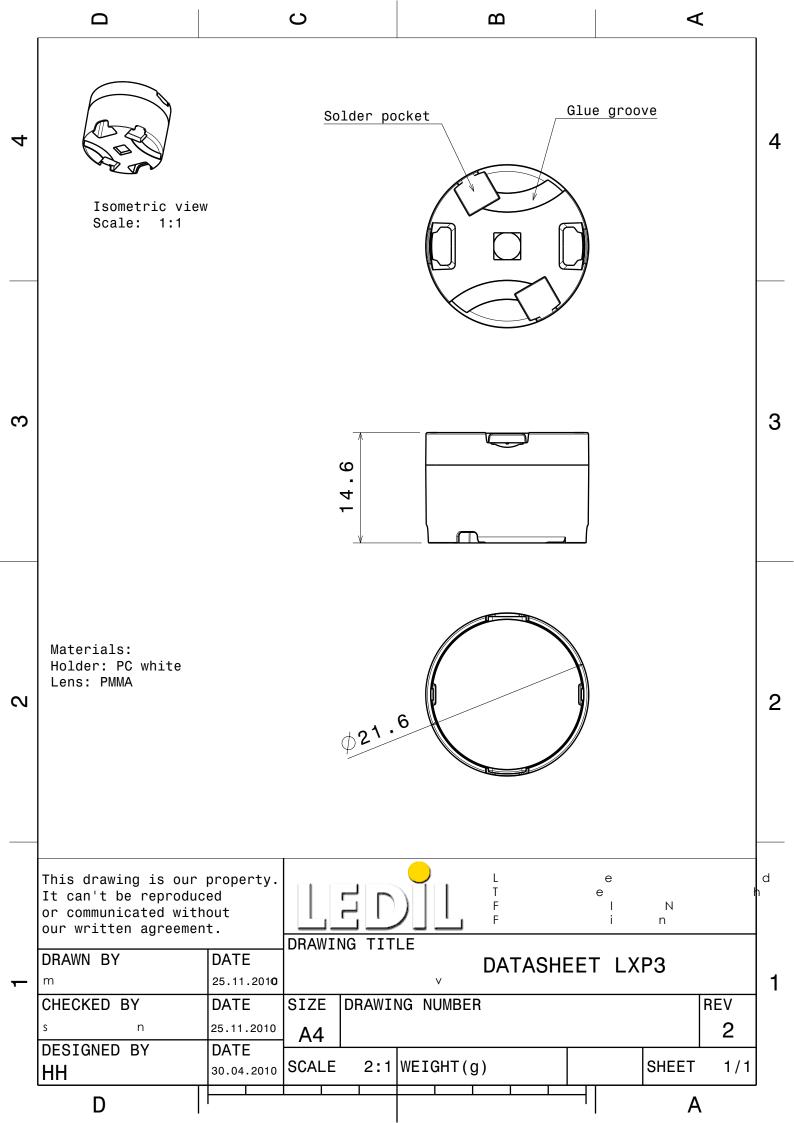
NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the glue.

NOTE 2: All surfaces where glue is applied must be clean, dry and free from grease and dirt. If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer -this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

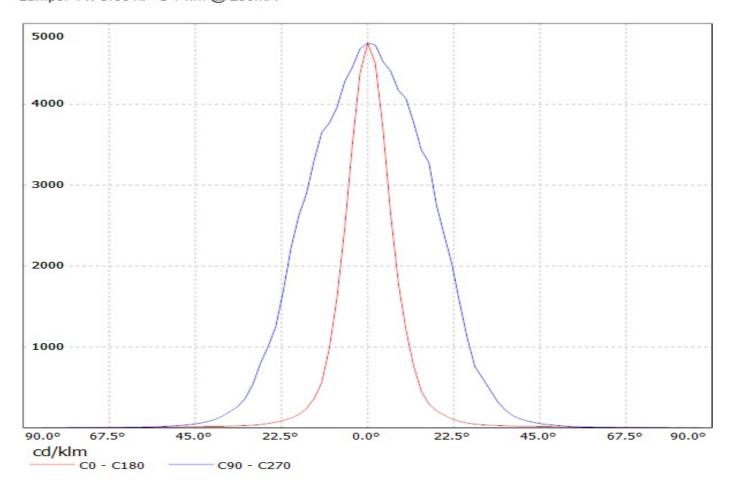
Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.

Relative intensity of CP11632_LXP3-D-XPG





Luminaire: Ledil Oy CP11634_LXP3-O-90 (Cree XP-G 71Im @ 250mA) Efficiency=93% Lamps: 1 x Cree XP-G 71Im @ 250mA



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